



PATENT
8040-1022

IN THE U.S. PATENT AND TRADEMARK OFFICE

In re application of

Hiroataka NAKANO et al.

Conf. 9420

Application No. 09/855,723

Group 2825

Filed May 16, 2001

Examiner Magid Y Dimyan

SYSTEM OF MANUFACTURING SEMICONDUCTOR
INTEGRATED CIRCUIT BY HAVING A CLIENT
CONNECTED TO A MANUFACTURER VIA
TWO-WAY COMMUNICATION

INFORMATION DISCLOSURE STATEMENT

MS ISSUE FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In compliance with Rules 1.97 and 1.98, and in fulfillment of the duty of disclosure under Rule 1.56, the accompanying documents, copies of which are attached to this statement, are made of record on the enclosed Form PTO-1449.

A concise explanation of the relevance of these items is that these references were cited by the Japanese Patent Office in the corresponding Japanese Application Serial No. 142918/2000, filed May 16, 2000. A copy of the Japanese Official Action in which they were cited is attached hereto, with what is believed to be the pertinent portion enclosed in a wavy line. **An English translation of the enclosed portion is also attached hereto.**

Under the provisions of 37 CFR 1.97(e), the undersigned hereby certifies that each item of information

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contained in this Information Disclosure Statement was first cited in any communication from a foreign Patent Office in a counterpart foreign application not more than three months prior to the filing of this Statement.

Charge the petition fee of \$180 to deposit account No. 25-0120.

Respectfully submitted,

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RJP/fb

July 12, 2005

* Abstract provided for the Examiner's convenience